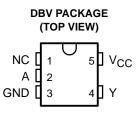
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- Inputs Are TTL-Voltage Compatible
- EPIC[™] (Enhanced-Performance Implanted CMOS) Process
- High Latch-Up Immunity Exceeds 250 mA Per JESD 17
- Packaged in Plastic Small-Outline Transistor Package



NC - No internal connection

description

The SN74AHCT1G14 contains a single inverter gate. The device performs the Boolean function $Y = \overline{A}$.

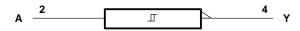
The device functions as an independent inverter gate, but because of the Schmitt action, gates may have different input threshold levels for positive- (V_{T+}) and negative-going (V_{T-}) signals.

The SN74AHCT1G14 is characterized for operation from -40°C to 85°C.

FUNCTION TABLE

INPUT A	OUTPUT Y
Н	L
L	Н

logic symbol†



[†]This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)





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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage range, V _{CC}	–0.5 V to 7 V
Input voltage range, V _I (see Note 1)	–0.5 V to 7 V
Output voltage range, V _O (see Note 1)	
Input clamp current, $I_{ K }(V_{ C } < 0)$	
Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$)	±20 mA
Continuous output current, $I_O(V_O = 0 \text{ to } V_{CC})$	±25 mA
Continuous current through V _{CC} or GND	±50 mA
Package thermal impedance, θ_{JA} (see Note 2)	347°C/W
Storage temperature range, T _{stq}	

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions (see Note 3)

		MIN	MAX	UNIT
VCC	Supply voltage	4.5	5.5	V
VIH	High-level input voltage	2		V
VIL	Low-level input voltage		0.5	V
٧ _I	Input voltage	0	5.5	V
٧o	Output voltage	0	VCC	V
IOH	High-level output current		-8	mA
l _{OL}	Low-level output current		8	mA
Δt/Δν	Input transition rise or fall rate		20	ns/V
TA	Operating free-air temperature	-40	85	°C

NOTE 3: Unused inputs must be held high or low to prevent them from floating.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DADAMETED	TEST COMPITIONS	\ \(\sigma_{-} \)	T _A = 25°C			MINI	MAY	LINUT
PARAMETER	TEST CONDITIONS	VCC	MIN	TYP	MAX	MIN	MAX	UNIT
V_{T+}		4.5 V			2		2	V
Positive-going input threshold voltage		5.5 V			2		2	٧
V _T _		4.5 V	0.5			0.5		V
Negative-going input threshold voltage		5.5 V	0.6			0.6		
ΔV_{T}	V _T 4.5 V	4.5 V	0.4		1.4	0.4	1.4	· V
Hysteresis ($V_{T+} - V_{T-}$)		5.5 V	0.5		1.6	0.4	1.6	
Vari	I _{OH} = -50 μA	4.5 V	4.4	4.5		4.4		V
Voн	$I_{OH} = -8 \text{ mA}$	7 4.5 V	3.94			3.8		
Va	I _{OL} = 50 μA	4.5 V			0.1		0.1	V
VoL	I _{OL} = 8 mA	7 4.5 V			0.36		0.44	V
I _I	$V_I = V_{CC}$ or GND	5.5 V			±0.1		±1	μΑ
Icc	$V_I = V_{CC}$ or GND, $I_O = 0$	5.5 V			1		10	μΑ
C _i	V _I = V _{CC} or GND	5 V		2	10		10	pF



NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

^{2.} The package thermal impedance is calculated in accordance with JESD 51.

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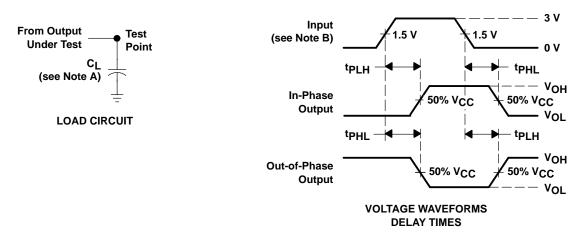
switching characteristics over recommended operating free-air temperature range, $V_{CC}=5~V\pm0.5~V$ (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD CAPACITANCE	T _A = 25°C			MIN	MAX	UNIT		
PARAMETER				MIN	TYP	MAX	IVIIN	WAX	UNII		
^t PLH	Δ.	Y	V	C: 45 pF		4	7	1	8		
^t PHL	А		Y C _L = 15 pF		4	7	1	8	ns		
^t PLH	Δ.	Y	V	A V	C 50 pF		5.5	8	1	9	20
tPHL	А		C _L = 50 pF		5.5	8	1	9	ns		

operating characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

	PARAMETER		ONDITIONS	TYP	UNIT
C _{pd}	Power dissipation capacitance	No load,	f = 1 MHz	12	pF

PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

- B. Input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, $Z_O = 50 \ \Omega$, $t_f = 3 \ ns$, $t_f = 3 \ ns$.
- C. The output is measured with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

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